

July 2016

Chip beads

For power line

HF-ACC series

HFxxACC3216_{Type}

HFxxACC3216 [1206 inch]*

* Dimensions code JIS[EIA]

Reminders for using these products

Before using these products, be sure to request the delivery specifications.

Safety reminders

Please pay sufficient attention to the warnings for safe designing when using this products.

⚠ Reminders
 The storage period is less than 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
On not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
 Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
 Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference.
○ Use a wrist band to discharge static electricity in your body through the grounding wire.
On not expose the products to magnets or magnetic fields.
On not use for a purpose outside of the contents regulated in the delivery specifications.
The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment

set forth in the each catalog, please contact us.

- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions



Chip beads

For power line

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders

Overview of HFxxACC3216 type

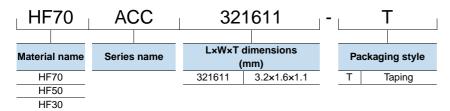
FEATURES

- O Noise reduction solution for power line.
- Achieves various frequency characteristics by using 3 materials with different features.
- O There is no directivity.

APPLICATION

Power line noise removal for DSCs, DVCs, PCs, TVs, printers, game machines, smart grids, wireless base stations, industrial equipment

■ PART NUMBER CONSTRUCTION



OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperati	ure ranges	Package quantity	Individual weight	
Туре	Operating temperature	Storage temperature*			
	(°C)	(°C)	(pieces/reel)	(mg)	
HFxxACC3216	-40 to +125	-40 to +125	2,000	22	

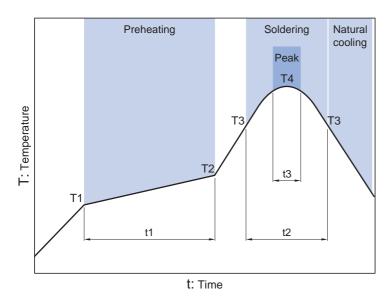
^{*} The storage temperature range is for after the circuit board is mounted.

RoHS Directive Compliant Product: See the following for more details.https://product.tdk.com/info/en/environment/rohs/index.html

O Halogen-free: indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.



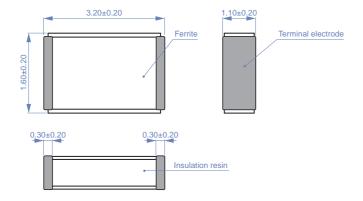
■ RECOMMENDED REFLOW PROFILE

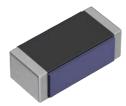


Soldering Preheating Peak Temp. Time Temp. Time Temp. Time T2 T1 T4 t1 Т3 t2 t3 150°C 180°C 60 to 120s 230°C 30 to 60s 250 to 260°C



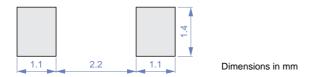
SHAPE & DIMENSIONS





Dimensions in mm

■ RECOMMENDED LAND PATTERN





ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

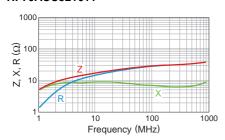
Impedance		DC resistance	Rated current	Part No.
[100MHz]				
(Ω)	Tolerance	(Ω)max.	(A)max.	
26	±25%	0.04	1.5	HF70ACC321611-T
31	±25%	0.04	1.5	HF50ACC321611-T
19	±25%	0.04	1.5	HF30ACC321611-T



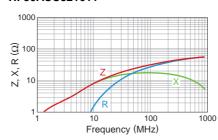
ELECTRICAL CHARACTERISTICS

□Z, X, R VS. FREQUENCY CHARACTERISTICS

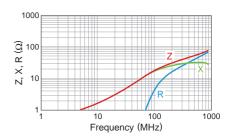
HF70ACC321611



HF50ACC321611



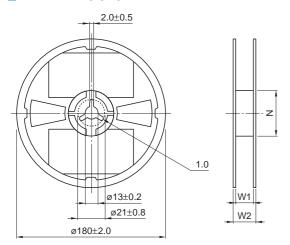
HF30ACC321611





■PACKAGING STYLE

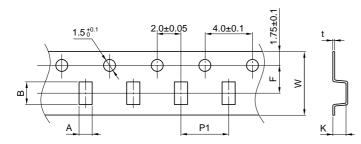
REEL DIMENSIONS



Type	W1	W2	N	
HFxxACC3216	8.4+2.0/-0.0	14.4max.	ø60min.	

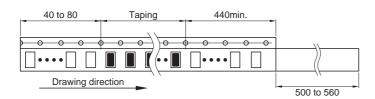
Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Туре	Α	В	F	P1	W	K	t
HFxxACC3216	1.75±0.1	3.45±0.1	3.5±0.05	4.0±0.1	8.0±0.3	1.4max.	0.3max.



Dimensions in mm